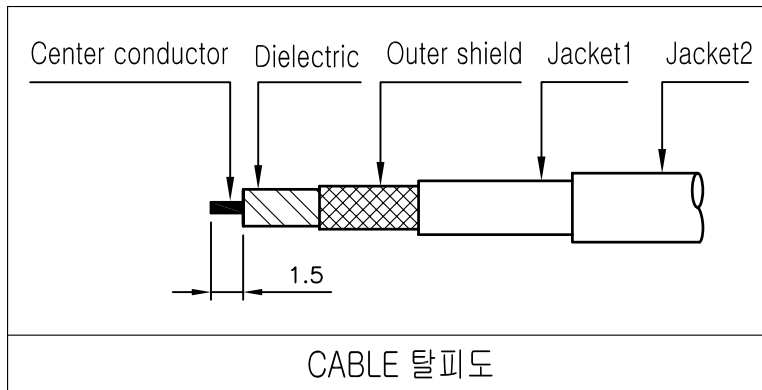
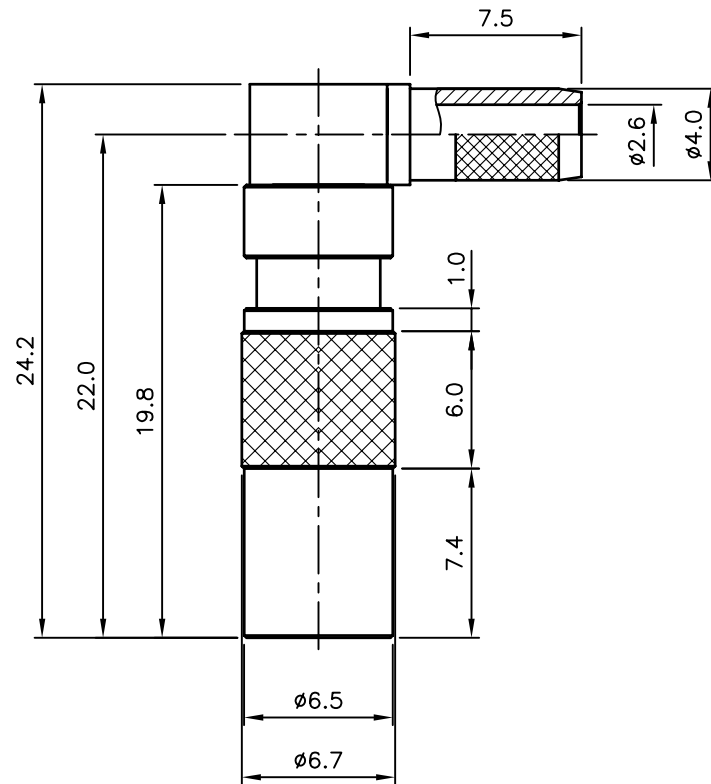
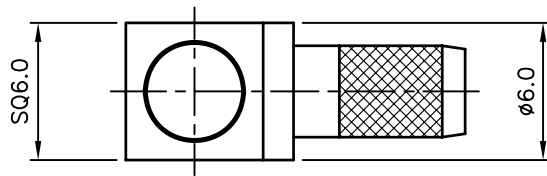
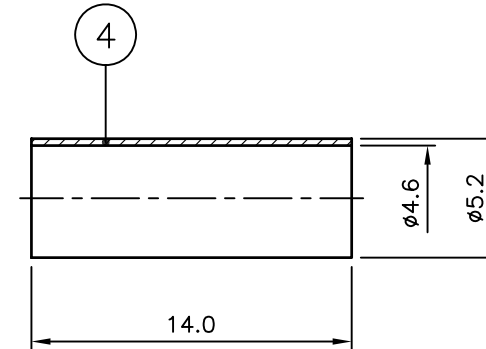




REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2020.01.02.
1	Jack 두께 변경 부러짐 개선	S.Y.EUN	I.C.KIM	2020.07.16.



8	COVER	1	MBsBD C3604BD-F	Nickel Plate	DCO00018-5/1
7	SPRING	1	BeCu C17300	Gold Plate	DSR00003-5/1
6	CAP	1	MBsBD C3604BD-F	Gold Plate	DCU02310-5/1
5	JACK	1	BeCu C17300	Gold Plate	DJA00064-5/2 DJA00064-5/1
4	FERRULE	1	MBsBD C3604BD-F	Nickel Plate	DFO00225-5/1
3	INSULATOR	1	TEFLON		DIN03108-N/1
2	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT04096-5/1
1	1-2 BODY (B)	1	MBsBD C3604BD-F	Nickel Plate	DBB00496-5/1 DBD04587-1/1
	1-1 BODY (A)	1	MBsBD C3604BD-F	Nickel Plate	DBB00496-5/1 DBD04586-1/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2020. 07. 16.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM		
MATERIAL	±1°	CHECKED BY	TITLE 1.0/2.3 DIN75 CABLE PL CFK0ax1.01 SCREW		
	_____	DRAWN BY			
FINISH	_____	SCALE 3/1	UNIT mm	 A4	DWG NO. CN03903-7/1
					REVISION 1